

2 Port, USB 2.0 High Speed (480 Mbps) Switch, DPDT Analog Switch

DESCRIPTION

The DG2722 is 2 port high speed analog switch optimized for USB 2.0 signal switching. The DG2722 switch is configured in DPDT. It handles bidirectional signal flow, achieving a 900 MHz - 3 dB bandwidth, and a port to port crosstalk and isolation at - 49 dB.

Processed with high density sub micron CMOS, the DG2722 provide low parasitic capacitance. Signals are routed with minimized phase distortion and attain a bit to bit skew is as low as 40 pS.

The DG2722 is designed for a wide range of operating voltages, from 2.7 V to 4.3 V that can be driven directly from one cell Li-ion battery. On-chip circuitry protects against conditions when either the D+/D- lines are shorted to the V_{BUS} at the USB port. Additionally, logic control pins (S and OE) can tolerate the presence of voltages that are above the supply power rail (V_{+}). The control logic threshold is guaranteed to be ($V_{IH} = 1.3$ V/min). Latch up current is 300 mA, as per JESD78, and its ESD tolerance exceeds 8 kV.

Packaged in ultra small miniQFN-10 (1.4 mm x 1.8 mm x 0.55 mm), it is ideal for portable high speed mix signal switching application.

As a committed partner to the community and the environment, Vishay Siliconix manufactures this product with lead (Pb)-free device termination. The miniQFN-10 package has a nickel-palladium-gold device termination and is represented by the lead (Pb)-free “-E4” suffix to the ordering part number. The nickel-palladium-gold device terminations meet all JEDEC standards for reflow and MSL rating.

As a further sign of Vishay Siliconix's commitment, the DG2722 is fully RoHS compliant.

FEATURES

- **Halogen-free according to IEC 61249-2-21 Definition**
- Wide operation voltage range
- Low on-resistance, $7\ \Omega$ (typical at 3 V)
- Low capacitance, $C_{ON} = 5.8$ pF (typical)
- 3 dB high bandwidth: 900 MHz (typical)
- Low bit to bit skew: 40 pS (typical)
- Low power consumption
- Low logic threshold: V
- Power down protection: D+/D- pins can tolerate up to 5 V when $V_{+} = 0$ V
- Logic (S and OE) above V_{+} tolerance
- 8 kV ESD protection (HBM)
- Latch-up current 300 mA per JESD78
- Lead (Pb)-free low profile miniQFN-10 (1.4 mm x 1.8 mm x 0.55 mm)
- **Compliant to RoHS Directive 2002/95/EC**

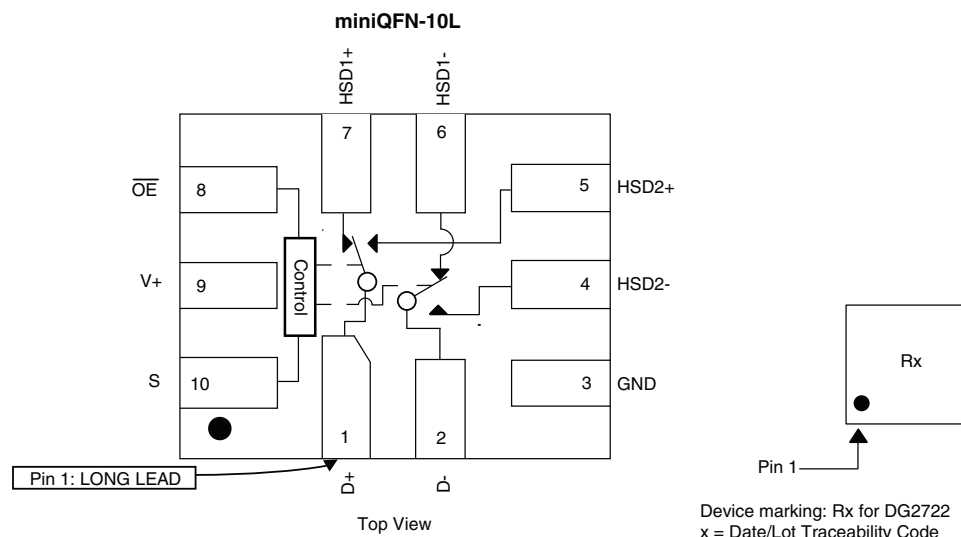


RoHS
COMPLIANT
HALOGEN
FREE

APPLICATIONS

- Cellular phones
- Portable media players
- PDA
- Digital camera
- GPS
- Notebook computer
- TV, monitor, and set top box

FUNCTIONAL BLOCK DIAGRAM AND PIN CONFIGURATION



ORDERING INFORMATION

Temp. Range	Package	Part Number
- 40 °C to 85 °C	miniQFN-10	DG2722DN-T1-E4

TRUTH TABLE

$\overline{OE}$ (Pin 8)	S (Pin 10)	Function
0	0	D+ = HSD1+ and D- = HSD1-
0	1	D+ = HSD2+ and D- = HSD2-
1	X	Disconnect

PIN DESCRIPTIONS

Pin Name	Description
$\overline{OE}$	Bus Switch Enable
S	Select Input
HSD1±, HSD2±, D±	Data Port

ABSOLUTE MAXIMUM RATINGS ($T_A = 25\text{ °C}$, unless otherwise noted)

Parameter	Limit	Unit
Reference to GND	V+	V
	S, $\overline{OE}$, D±, HSD1±, HSD2± ^a	
Current (Any Terminal except S, $\overline{OE}$, D±, HSD1±, HSD2±)	30	mA
Continuous Current (S, $\overline{OE}$, D±, HSD1±, HSD2±)	± 250	
Peak Current (Pulsed at 1 ms, 10 % Duty Cycle)	± 500	
Storage Temperature (D Suffix)	- 65 to 150	°C
Power Dissipation (Packages) ^b	miniQFN-10 ^c	mW
ESD (Human Body Model) I/O to GND	8	kV
Latch-up (Current Injection)	300	mA

Notes:

- a. Signals on S, $\overline{OE}$, D±, HSD1±, HSD2± exceeding V+ will be clamped by internal diodes. Limit forward diode current to maximum current ratings.
- b. All leads welded or soldered to PC board.
- c. Derate 2.6 mW/°C above 70 °C.

SPECIFICATIONS ($V_+ = 3\text{ V}$)

Parameter	Symbol	Test Conditions Otherwise Unless Specified	Temp. ^a	Limits - 40 °C to 85 °C			Unit
				Min. ^b	Typ. ^c	Max. ^b	
Analog Switch							
Analog Signal Range ^d	V _{ANALOG}	R _{DS(on)}	Full	0		V+	V
On-Resistance	R _{DS(on)}	V+ = 3 V, I _{D±} = 8 mA, V _{HSD1/2±} = 0.4 V	Room		7	8	Ω
			Full			9	
On-Resistance Match ^d	ΔR _{ON}	V+ = 3 V, I _{D±} = 8 mA, V _{HSD1/2±} = 0.4 V	Room		0.8		
On-Resistance Resistance Flatness ^d	R _{ON} Flatness	V+ = 3 V, I _{D±} = 8 mA, V _{HSD1/2±} = 0 V, 1 V	Room		2		
Switch Off Leakage Current	I _(off)	V+ = 4.3 V, V _{HSD1/2±} = 0.3 V, 3 V, V _{D±} = 3 V, 0.3 V	Full	- 100		100	nA
Channel On Leakage Current	I _(on)	V+ = 4.3 V, V _{HSD1/2±} = 0.3 V, 4 V, V _{D±} = 4 V, 0.3 V	Full	- 200		200	
Digital Control							
Input Voltage High	V _{INH}	V+ = 3 V to 3.6 V	Full	1.3			V
		V+ = 4.3 V	Full	1.5			
Input Voltage Low	V _{INL}	V+ = 3 V to 4.3 V	Full			0.5	
Input Capacitance	C _{IN}		Full		6.5		pF
Input Current	I _{INL} or I _{INH}	V _{IN} = 0 or V+	Full	- 1		1	μA



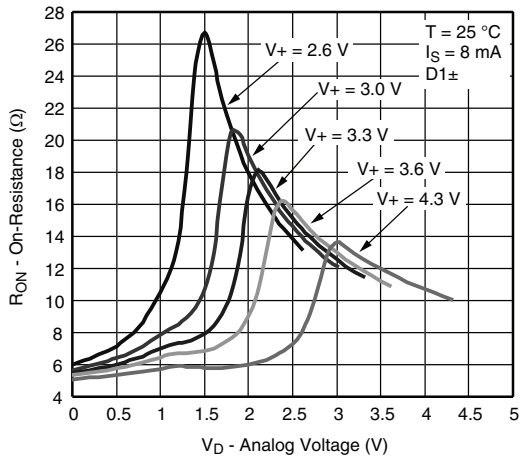
SPECIFICATIONS (V+ = 3 V)							
Parameter	Symbol	Test Conditions Otherwise Unless Specified	Temp. ^a	Limits - 40 °C to 85 °C			Unit
				Min. ^b	Typ. ^c	Max. ^b	
Dynamic Characteristics							
Break-Before-Make Time ^{e, d}	t _{BBM}	V+ = 3 V, V _{D1/2} ± 1.5 V, R _L = 50 Ω, C _L = 35 pF	Room		5		ns
			Full				
S, $\overline{\text{OE}}$ Turn-On Time ^{e, d}	t _{ON}		Room			30	
			Full				
S, $\overline{\text{OE}}$ Turn-Off Time ^{e, d}	t _{OFF}		Room			25	
			Full				
Charge Injection ^d	Q _{INJ}	C _L = 1 nF, R _{GEN} = 0 Ω, V _{GEN} = 0 V	Room		0.5		pC
Off-Isolation ^d	OIRR	V+ = 3 V to 3.6 V, R _L = 50 Ω, C _L = 5 pF, f = 240 MHz			- 30		dB
Crosstalk ^d	X _{TALK}				- 45		
Bandwidth ^d	BW	V+ = 3 V to 3.6 V, R _L = 50 Ω, - 3 dB			900		MHz
D+/D- On Capacitance	C _{ON}	V+ = 3.3 V, $\overline{\text{OE}}$ = 0 V, f = 240 MHz			5.8		pF
D1n, D2n Off Capacitance	C _{OFF}	V+ = $\overline{\text{OE}}$ = 3.3 V, f = 240 MHz			2.2		
Channel-to-Channel Skew ^d	t _{SK(O)}	V+ = 3 V to 3.6 V, R _L = 50 Ω, C _L = 5 pF			50		ps
Skew Off Opposite Transitions of the Same Output ^d	t _{SK(P)}				20		
Total Jitter ^d	t _J				200		
Power Supply							
Power Supply Range	V+			2.6		4.3	V
Power Supply Current	I+	V _{IN} = 0 V, or V+	Full			2	μA

Notes:

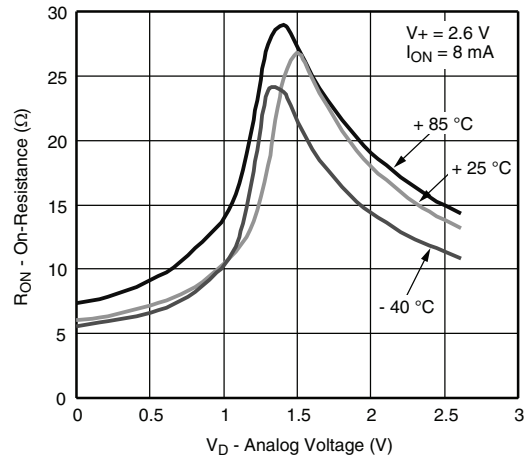
- Room = 25 °C, Full = as determined by the operating suffix.
- The algebraic convention whereby the most negative value is a minimum and the most positive a maximum, is used in this datasheet.
- Typical values are for design aid only, not guaranteed nor subject to production testing.
- Guarantee by design, not subjected to production test.
- V_{IN} = input voltage to perform proper function.
- Crosstalk measured between channels.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

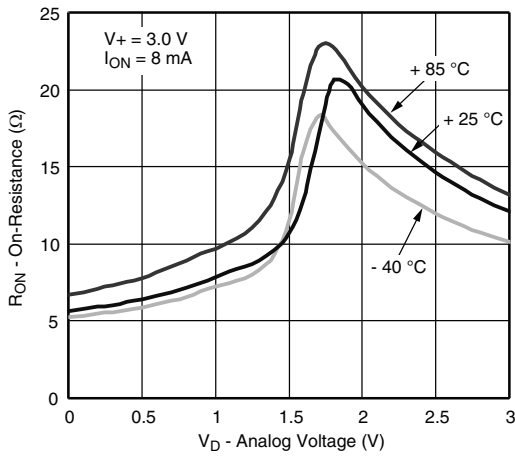
TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)



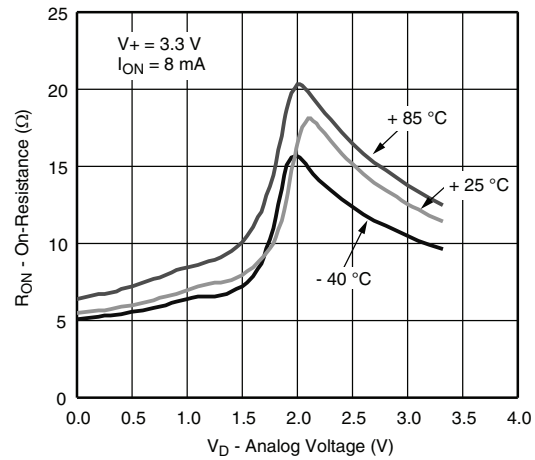
R_{ON} vs. V_D and Single Supply Voltage



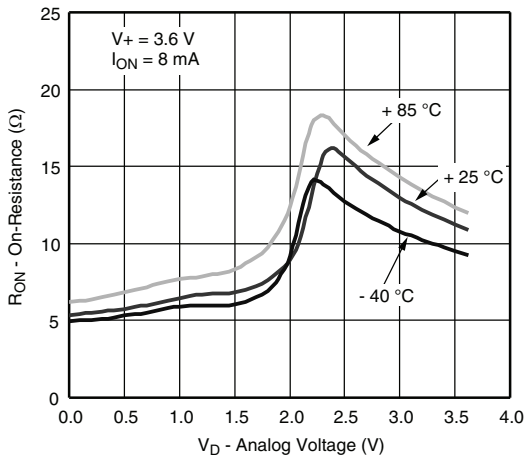
R_{ON} vs. Analog Voltage and Temperature



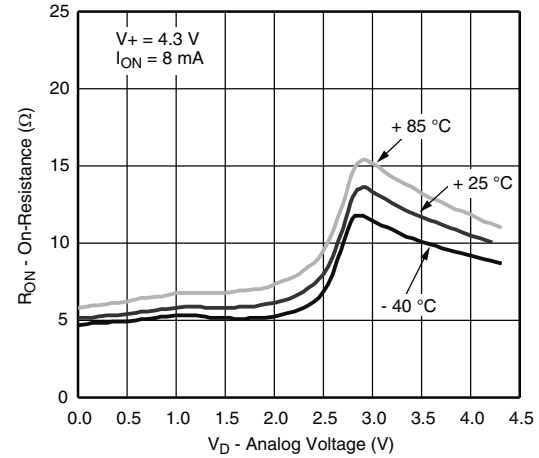
R_{ON} vs. Analog Voltage and Temperature



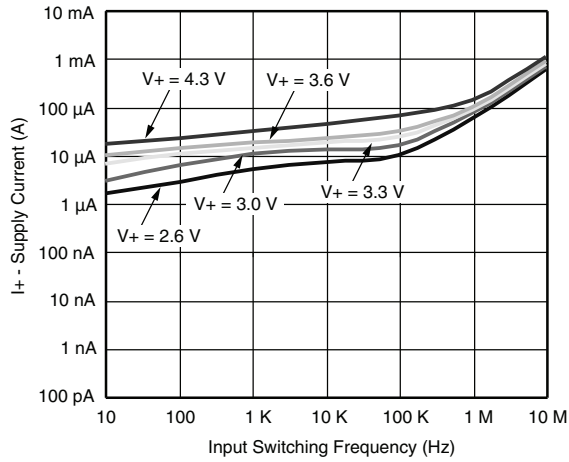
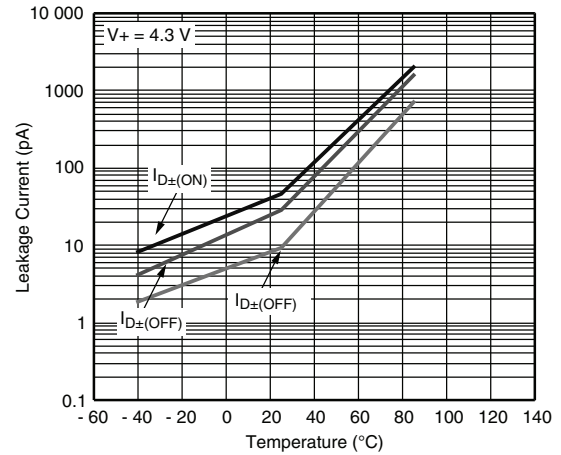
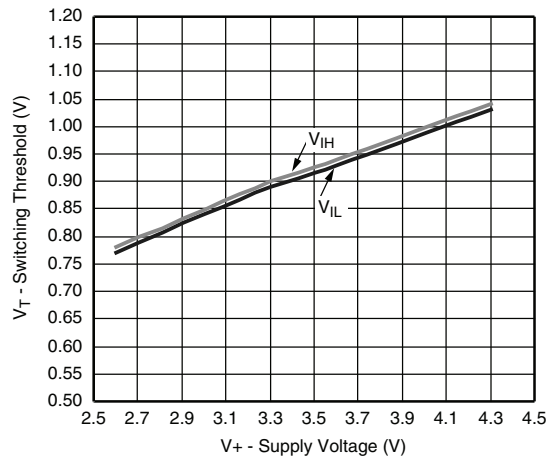
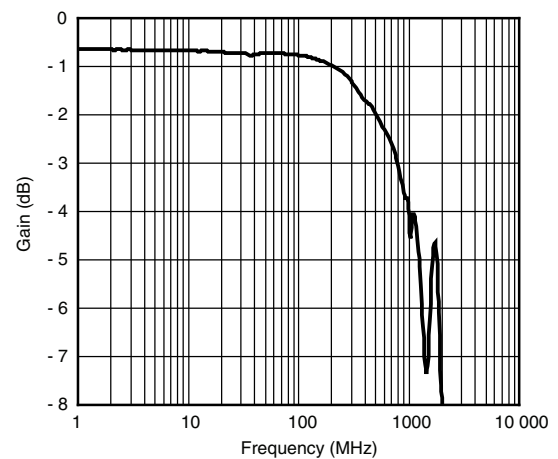
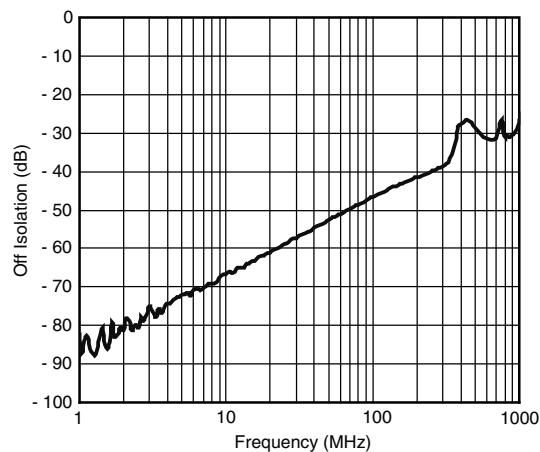
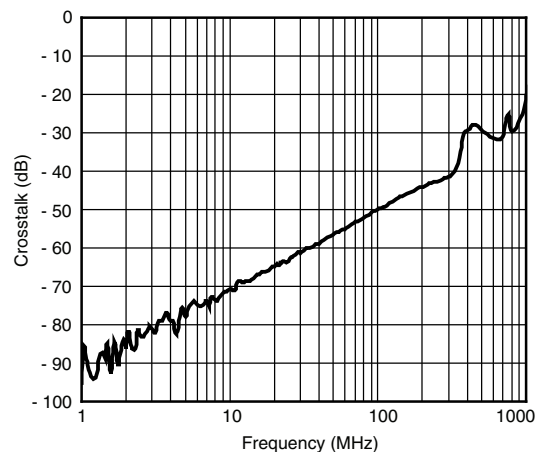
R_{ON} vs. Analog Voltage and Temperature



R_{ON} vs. Analog Voltage and Temperature



R_{ON} vs. Analog Voltage and Temperature

TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$, unless otherwise noted)

Supply Current vs. Input Switching Frequency

Leakage Current vs. Temperature

Switching Threshold vs. Supply Voltage

Gain vs. Frequency, $V_{+} = 3.3\text{ V}$

Off-Isolation, $V_{+} = 3.3\text{ V}$

Crosstalk, $V_{+} = 3.3\text{ V}$

TEST CIRCUITS

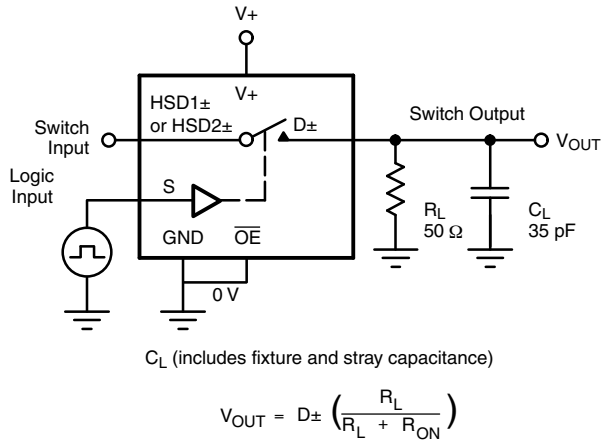
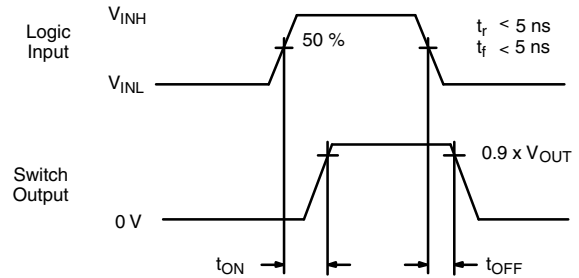


Figure 1. Switching Time



Logic "1" = Switch on
Logic input waveforms inverted for switches that have the opposite logic sense.

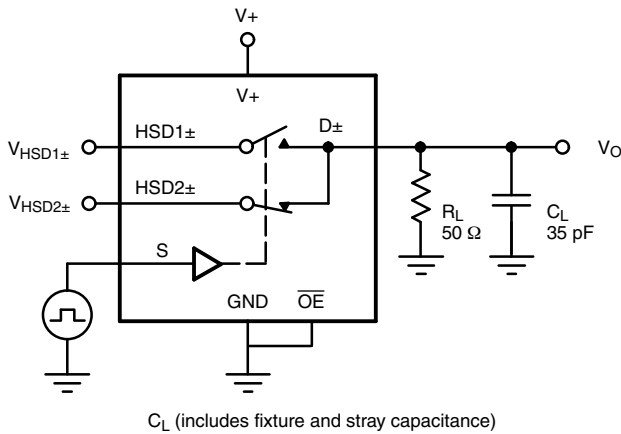


Figure 2. Break-Before-Make Interval

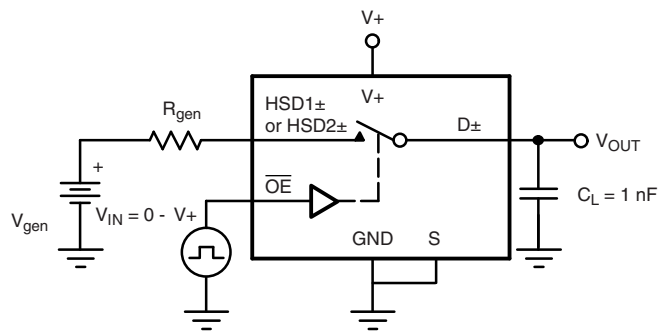
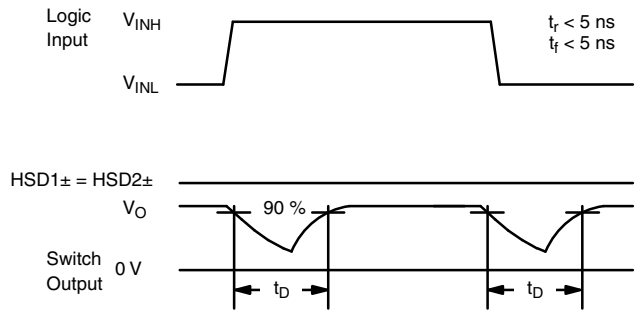
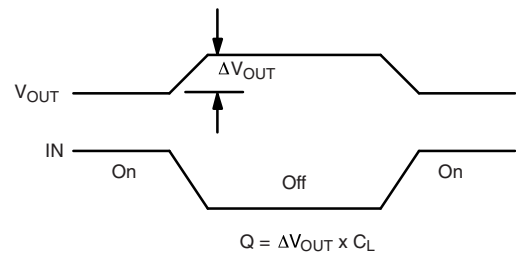
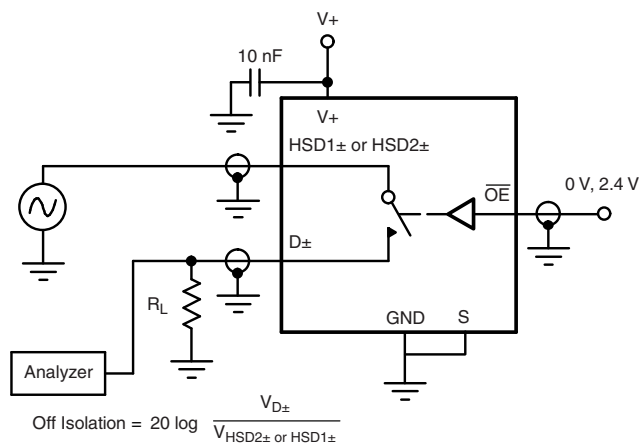
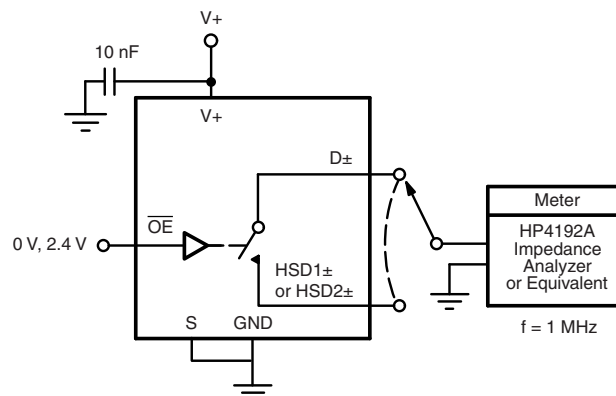


Figure 3. Charge Injection

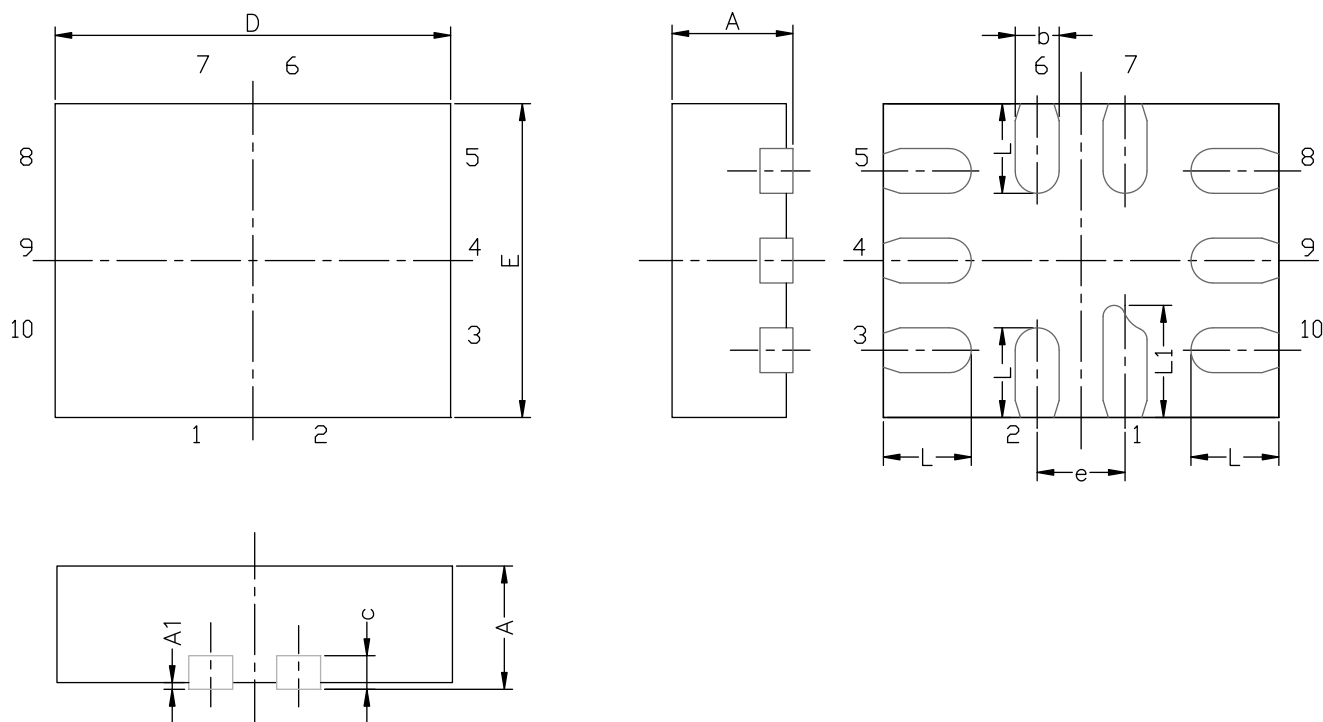


IN depends on switch configuration: input polarity determined by sense of switch.

TEST CIRCUITS

Figure 4. Off-Isolation

Figure 5. Channel Off/On Capacitance

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?68379.

MINI QFN-10L CASE OUTLINE



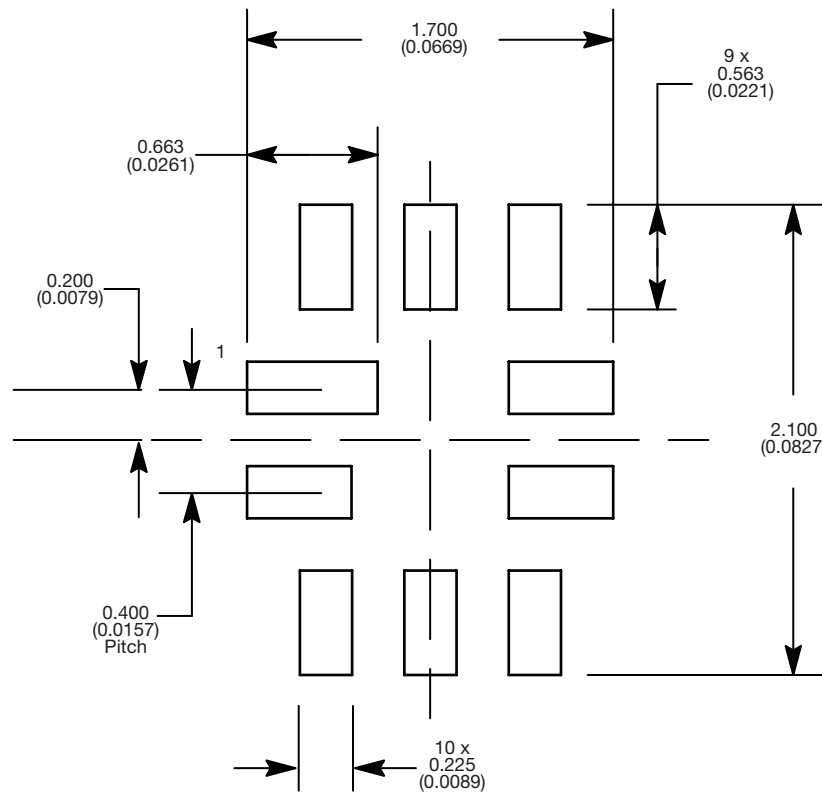
DIM	MILLIMETERS			INCHES		
	MIN.	NAM.	MAX.	MIN.	NAM.	MAX.
A	0.45	0.55	0.60	0.0177	0.0217	0.0236
A1	0.00	-	0.05	0.000	-	0.002
b	0.15	0.20	0.25	0.006	0.008	0.010
c	0.150 or 0.127 REF ⁽¹⁾			0.006 or 0.005 REF ⁽¹⁾		
D	1.70	1.80	1.90	0.067	0.071	0.075
E	1.30	1.40	1.50	0.051	0.055	0.059
e	0.40 BSC			0.016 BSC		
L	0.35	0.40	0.45	0.014	0.016	0.018
L1	0.45	0.50	0.55	0.0177	0.0197	0.0217

Note

⁽¹⁾ The dimension depends on the leadframe that assembly house used.

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DWG: 5957

RECOMMENDED MINIMUM PADS FOR MINI QFN 10L



Mounting Footprint
Dimensions in mm (inch)



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